

# **Biography**

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S. M. Taslim Uddin Raju Lecturer Research AreaBiomedical Image Processing Bioinformatics Deep Learning Machine Learning

## **Education**

#### M. Sc. in Computer Science and Engineering

Khulna University of Engineering & Technology (KUET), Bangladesh((July, 2019-Present).-)

#### **B.Sc.in Computer Science and Engineering**

Khulna University of Engineering & Technology (KUET), Bangladesh (2015-2019) Achievement: University Dean Awards

#### **Service Records**

Lecturer

**Department/Section:** Computer Science and Engineering **Khulna University of Engineering & Technology (KUET)** From 01-01-1970 to 01-01-1970 Working Area:Teaching

Lecturer

**Department/Section:** Computer Science and Engineering **Eastern University (EU)** From 01-01-1970 to 01-01-1970 Working Area:Teaching

## **Research Interest**

Biomedical			
Image Processing			
Bioinformatics			
Deep Learning			
Machine Learning			
Publication			

# Books

# Journals

- 4. Golap, 2. A., Raju, S. M. T. U., Haque, M. R. and Hashem, M. M. A. (2021), "Hemoglobin and Glucose Level Estimation from PPG Characteristics Features of Fingertip Video Using MGGP-Based Model," *Biomedical Signal Processing and Control*, Elsevier, vol67
- 3. Haque,1. R. , Raju,S. M. T. U. , Golap,M. A. and Hashem,M. M. A. (2021) , " A Novel Technique for Non-Invasive Measurement of Human Blood Component Levels From Fingertip Video Using DNN Based Models," *IEEE ACCESS*, IEEE, vol9
- 2. Ullah,S. M. A. , Islam,M. M. , Mahmud,S. , Nooruddin,S. and Haque,S. M. T. U. R. &. M. R. (2020) , " Scalable Telehealth Services to Combat Novel Coronavirus (COVID-19) Pandemic," *SN Computer Science* , Springer
- 1. Islam, M. M., Ullah, S. M. A. and Raju, S. M. &. S. M. T. U. (2020), "Breathing Aid Devices to Support Novel Coronavirus (COVID-19)Infected Patients," *SN COMPUT*, Springer

## Conference

1. Raju,S. M. T. U. and Rahman,M. S. (5-7 June 2020), "Horizontal Vertical and SuperQueen Parity (HVSQ) Method for Soft Error Tolerance," **2020 IEEE Region 10 Symposium (TENSYMP)**, IEEE, pp.1734-1737